

DESCRIPTION

FEATURES

The PS2501-1. PS2501-2 and PS2501-4 series of optically coupled isolator consist of an infrared light emitting diode and an NPN silicon photo transistor in a space efficient Dual In Line Plastic Package.

PS2501-1

AC Isolation Voltage 5300V_{RMS}

- CTR Selections Available
- Wide Operating Temperature Range -30°C to +100°C
- Lead Free and RoHS Compliant
- UL File E91231 Package Code "EE"
- VDE Approval Certificate No. 40028086

PS2501-4

APPLICATIONS

- **Computer Terminals**
- **Industrial System Controllers**
- Measuring Instruments
- Signal Transmission between Systems of Different Potentials and Impedances

ORDER INFORMATION

- Add X after PN for VDE Approval
- Add G after PN for 10mm lead spacing
- Add SM after PN for Surface Mount
- Add SMT&R after PN for Surface Mount Tape & Reel

(Available for PS2501-1SM and PS2501-2SM)

ABSOLUTE MAXIMUM RATINGS

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Input

PS2501-2

Forward Current	50mA
Reverse Voltage	6V
Power dissipation	70mW

Output

Collector to Emitter Voltage BV _{CEO}	80V
Emitter to Collector Voltage BV _{ECO}	6V
Collector Current	50mA
Power Dissipation	150mW

Total Package

-30 to +100 °C Operating Temperature Storage Temperature -55 to +125 °C Total Power Dissipation 200mW

(derate linearly 2.67mW/°C at >25°C)

Lead Soldering Temperature (10s) 260°C

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ELECTRICAL CHARACTERISTICS (Ambient Temperature = 25°C unless otherwise specified)

INPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	$V_{\rm F}$	$I_F = 20 \text{mA}$		1.2	1.4	V
Reverse Voltage	V_R	$I_R = 10\mu A$	6.0			V
Reverse Leakage	I_R	$V_R = 4V$			10	μΑ
Terminal Capacitance	C_{t}	V = 0V, $f = 1KHz$		30	250	pF

OUTPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector—Emitter Breakdown Voltage	BV_{CEO}	$I_C = 1 \text{mA}, I_F = 0 \text{mA}$	80			V
Emitter—Collector Breakdown Voltage	$\mathrm{BV}_{\mathrm{ECO}}$	$I_E = 100\mu A, I_F = 0mA$	6			V
Collector-Emitter Dark Current	I_{CEO}	$V_{CE} = 20V$, $I_F = 0mA$			100	nA

COUPLED

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Current transfer ratio	CTR	$I_F = 5 \text{mA}, V_{CE} = 5 \text{V}$	80		600	%
		Optional CTR Grades GR L (PS2501-1 only)	100 200		300 400	
Collector—Emitter Saturation Voltage	V _{CE(sat)}	$I_F = 10 \text{mA}, I_C = 2 \text{mA}$			0.3	V
Input to Output Isolation Voltage	$V_{\rm ISO}$	AC 1 minute, RH = 40 to 60% Note 1	5300			V_{RMS}
Input to Output Isolation Resistance	R _{ISO}	V _{IO} = 500V Note 1	5x10 ¹⁰			Ω
Output Rise Time	t _r	$V_{CE} = 2V, Ic = 2mA, R_{L} = 100\Omega$		4	18	μs
Output Fall Time	t_{f}	$V_{CE} = 2V$, $Ic = 2mA$, $R_L = 100\Omega$		3	18	μs

Note 1: Measure with input leads shorted together and output leads shorted together.



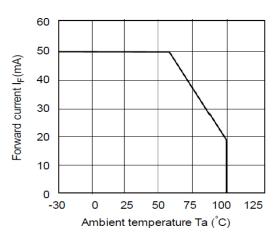


Fig 1 Forward Current vs T_A

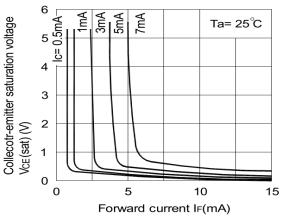


Fig 3 Collector-emitter Saturation Voltage vs Forward Current

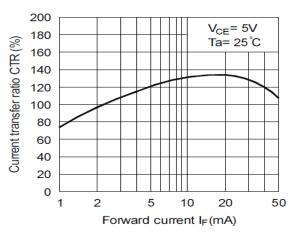


Fig 5 Current Transfer Ratio vs Forward Current

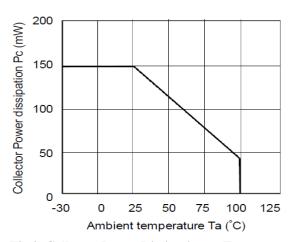


Fig 2 Collector Power Dissipation vs T_A

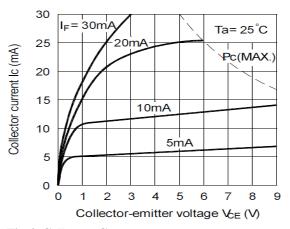


Fig 4 Collector Current vs Collector-emitter Voltage

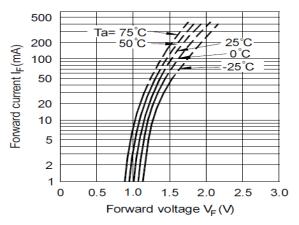


Fig 6 Forward Current vs Forward Voltage



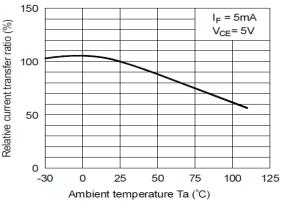


Fig 7 Relative CTR vs T_A

V_{CE}= 2V lc= 2mA

Ta= 25℃

500

200

100

50 20

10

5

2

1

0.5 0.2 0.05

Response time (μ s)



10

Fig 9 Response Time vs Load Resistance

0.1 0.2

0.5

Load resistance $R_L(k\Omega)$

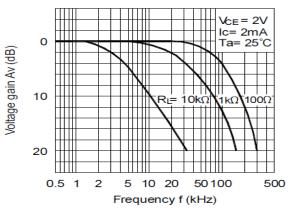
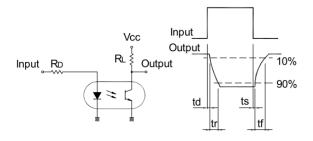
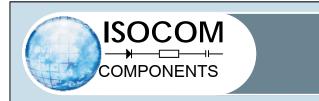


Fig 8 Frequency Response



Response Time Test Circuit



ORDER INFORMATION

	PS2501-1 (UL Approval)				
After PN	PN	Description	Packing quantity		
None	PS2501-1, PS2501-1GR, PS2501-1L	Standard DIP4	100 pcs per tube		
G	PS2501-1G, PS2501-1GRG, PS2501-1LG	10mm Lead Spacing	100 pcs per tube		
SM	PS2501-1SM, PS2501-1GRSM, PS2501-1LSM	Surface Mount	100 pcs per tube		
SMT&R	PS2501-1SMT&R, PS2501-1GRSMT&R, PS2501-1LSMT&R	Surface Mount Tape & Reel	1000 pcs per reel		

	PS2501-2 (UL Approval)					
After PN	PN	Description	Packing quantity			
None	PS2501-2, PS2501-2GR	Standard DIP8	50 pcs per tube			
G	PS2501-2G, PS2501-2GRG	10mm Lead Spacing	50 pcs per tube			
SM	PS2501-2SM, PS2501-2GRSM	Surface Mount	50 pcs per tube			
SMT&R	PS2501-2SMT&R, PS2501-2GRSMT&R,	Surface Mount Tape & Reel	1000 pcs per reel			

	PS2501-4 (UL Approval)					
After PN	PN	Description	Packing quantity			
None	PS2501-4, PS2501-4GR	Standard DIP16	25 pcs per tube			
G	PS2501-4G, PS2501-4GRG	10mm Lead Spacing	25 pcs per tube			
SM	PS2501-4SM, PS2501-4GRSM	Surface Mount	25 pcs per tube			

CTR grade "L" available only for PS2501-1.



ORDER INFORMATION

	PS2501-1X (UL and VDE Approvals)					
After PN	PN	Description	Packing quantity			
None	PS2501-1X, PS2501-1XGR, PS2501-1XL	Standard DIP4	100 pcs per tube			
G	PS2501-1XG, PS2501-1XGRG, PS2501-1XLG	10mm Lead Spacing	100 pcs per tube			
SM	PS2501-1XSM, PS2501-1XGRSM, PS2501-1XLSM	Surface Mount	100 pcs per tube			
SMT&R	PS2501-1XSMT&R, PS2501-1XGRSMT&R, PS2501-1XLSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

	PS2501-2X (UL and VDE Approvals)					
After PN	PN	Description	Packing quantity			
None	PS2501-2X, PS2501-2XGR	Standard DIP8	50 pcs per tube			
G	PS2501-2XG, PS2501-2XGRG	10mm Lead Spacing	50 pcs per tube			
SM	PS2501-2XSM, PS2501-2XGRSM,	Surface Mount	50 pcs per tube			
SMT&R	PS2501-2XSMT&R, PS2501-2XGRSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

	PS2501-4X (UL and VDE Approvals)					
After PN	PN	Description	Packing quantity			
None	PS2501-4X, PS2501-4XGR,	Standard DIP16	25 pcs per tube			
G	PS2501-4XG, PS2501-4XGRG	10mm Lead Spacing	25 pcs per tube			
SM	PS2501-4XSM, PS2501-4XGRSM	Surface Mount	25 pcs per tube			

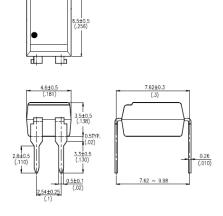
CTR grade "L" available only for PS2501-1.



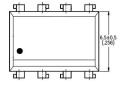
PACKAGE DIMENSIONS in mm (inch)

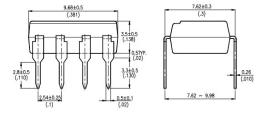
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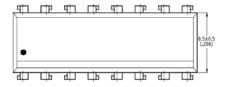


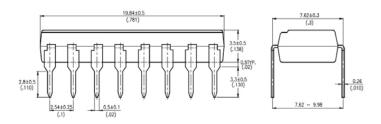
PS2501-2





PS2501-4



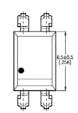


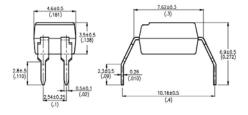


PACKAGE DIMENSIONS in mm (inch)

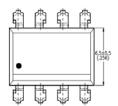
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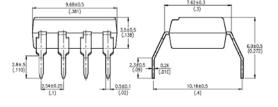




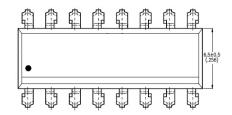


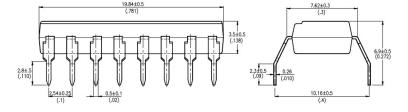
PS2501-2G





PS2501-4G



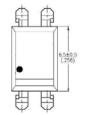


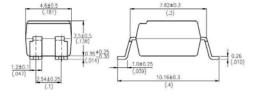


PACKAGE DIMENSIONS in mm (inch)

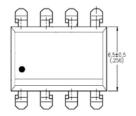
SMD

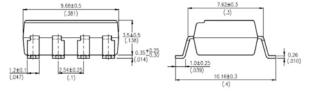




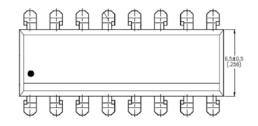


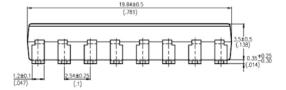
PS2501-2SM

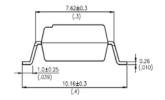




PS2501-4SM

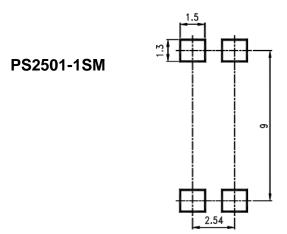


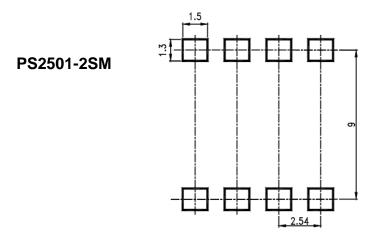


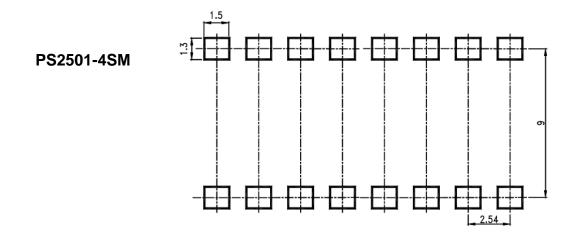




RECOMMENDED PAD LAYOUT FOR SMD (mm)

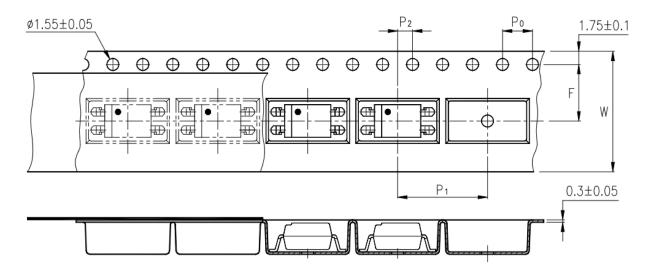




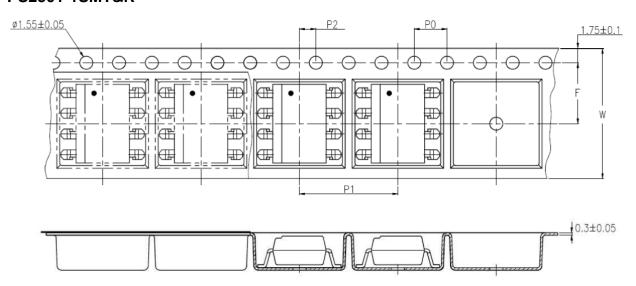




TAPE AND REEL PACKAGING



PS2501-1SMT&R

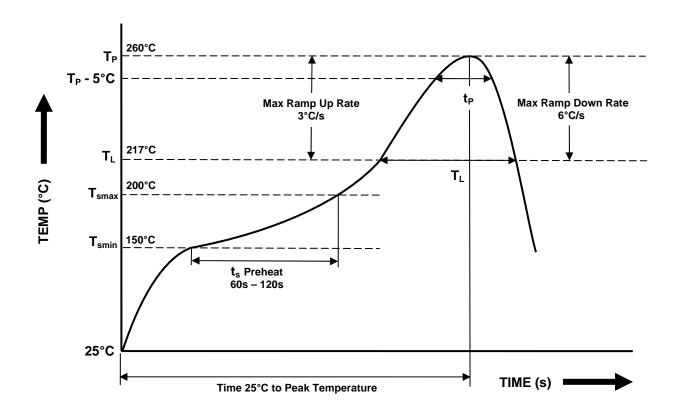


PS2501-2SMT&R

Description	Symbol	Dimensions in mm (inches)
Tape wide	W	$16 \pm 0.3 \ (.63)$
Pitch of sprocket holes	P ₀	4 ± 0.1 (.15)
Distance of commentment	F	$7.5 \pm 0.1 (.295)$
Distance of compartment	P ₂	$2 \pm 0.1 (.079)$
Distance of compartment to compartment	P ₁	$12 \pm 0.1 (.472)$



IR REFLOW SOLDERING TEMPERATURE PROFILE FOR SMD (One Time Reflow Soldering is Recommended)

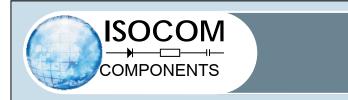


Profile Details	Conditions
$ \begin{array}{l} \textbf{Preheat} \\ \textbf{- Min Temperature } (T_{SMIN}) \\ \textbf{- Max Temperature } (T_{SMAX}) \\ \textbf{- Time } T_{SMIN} \text{ to } T_{SMAX} \left(t_s\right) \end{array} $	150°C 200°C 60s - 120s
$\begin{tabular}{lll} \textbf{Soldering Zone} \\ - & \begin{tabular}{l} - $	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T _{smax} to T _P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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